

To our customers,

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## Old Company Name in Catalogs and Other Documents

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April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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EOL announced Product

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## 2SK2738

Silicon N Channel MOS FET  
High Speed Power Switching

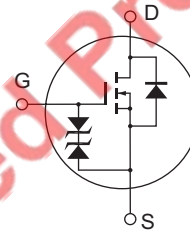
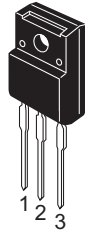
REJ03G1032-0200  
(Previous: ADE-208-483)  
Rev.2.00  
Sep 07, 2005

### Features

- Low on-resistance  
 $R_{DS} = 15 \text{ m}\Omega$  typ
- High speed switching
- 4 V gate drive device can be driven from 5 V source

### Outline

RENESAS Package code: PRSS0003AE-A  
(Package name: TO-220C•FM)



1. Gate
2. Drain
3. Source

## Absolute Maximum Ratings

(Ta = 25°C)

| Item                                      | Symbol              | Ratings     | Unit |
|---|---------------------|-------------|------|
| Drain to source voltage                   | $V_{DSS}$           | 60          | V    |
| Gate to source voltage                    | $V_{GSS}$           | ±20         | V    |
| Drain current                             | $I_D$               | 40          | A    |
| Drain peak current                        | $I_{D(pulse)}^{*1}$ | 160         | A    |
| Body to drain diode reverse drain current | $I_{DR}$            | 40          | A    |
| Avalanche current                         | $I_{AP}^{*3}$       | 40          | A    |
| Avalanche Energy                          | $E_{AR}^{*3}$       | 137         | mJ   |
| Channel dissipation                       | $P_{ch}^{*2}$       | 30          | W    |
| Channel temperature                       | Tch                 | 150         | °C   |
| Storage temperature                       | Tstg                | -55 to +150 | °C   |

- Notes: 1.  $PW \leq 10 \mu s$ , duty cycle  $\leq 1 \%$   
 2. Value at  $T_c = 25^\circ C$   
 3. Value at  $T_{ch} = 25^\circ C$ ,  $R_g \geq 50 \Omega$

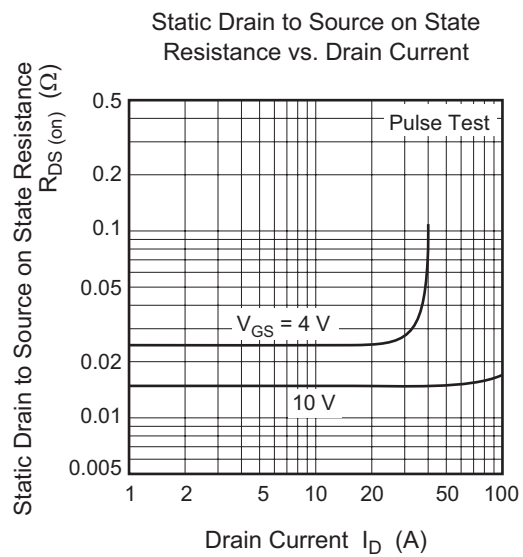
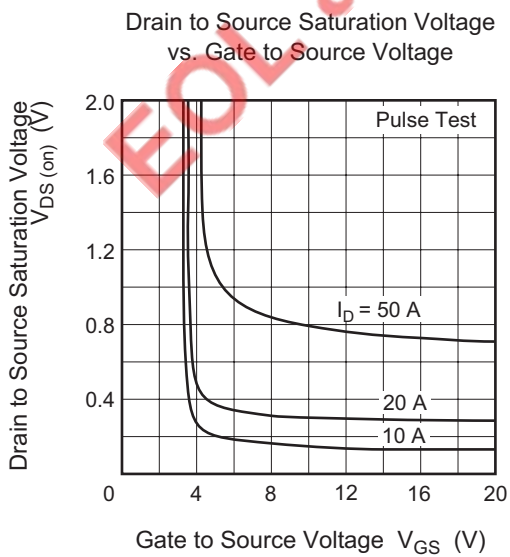
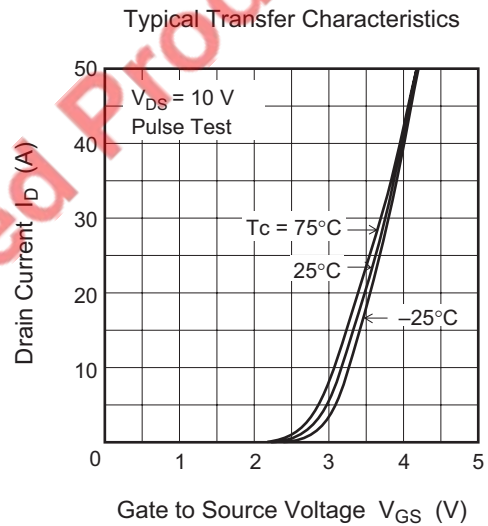
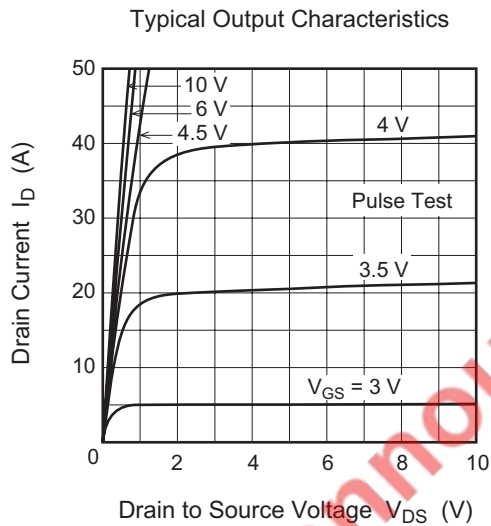
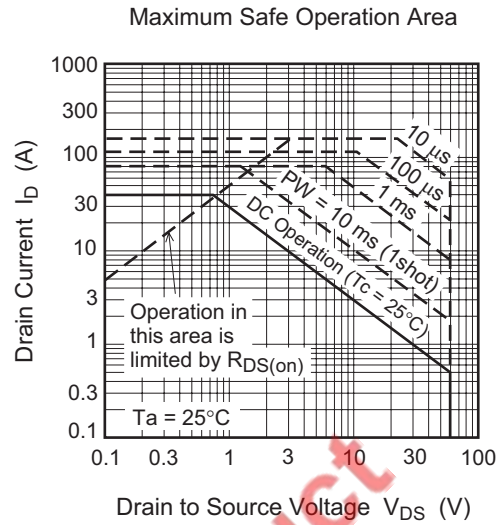
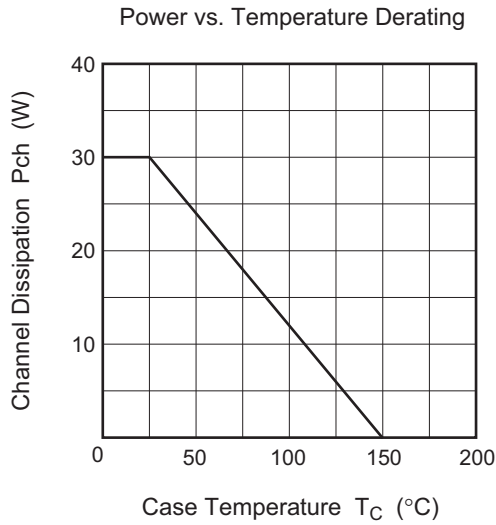
## Electrical Characteristics

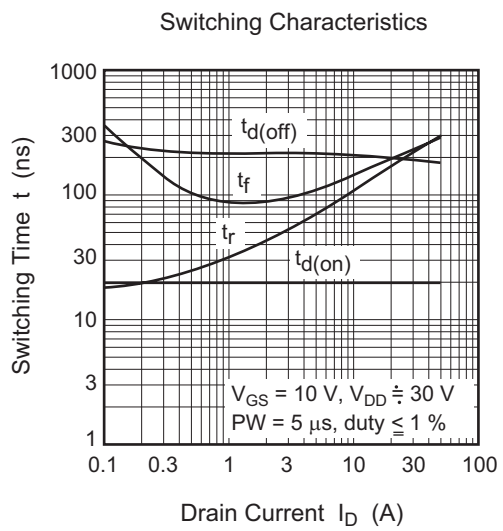
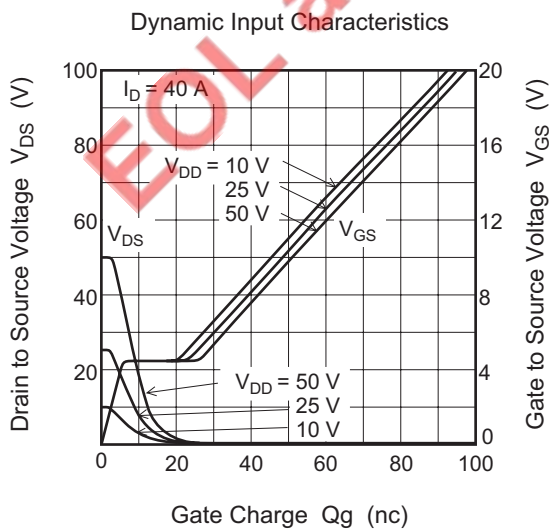
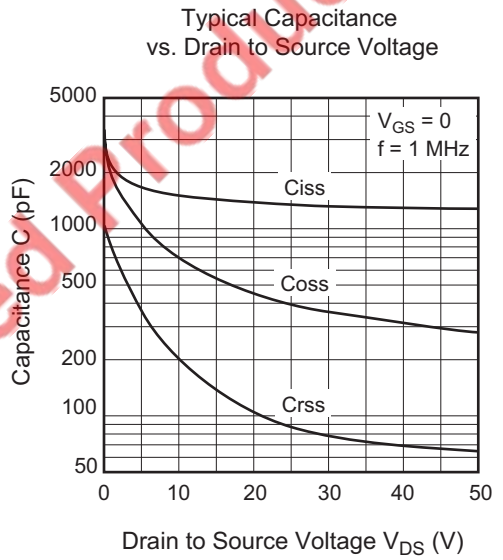
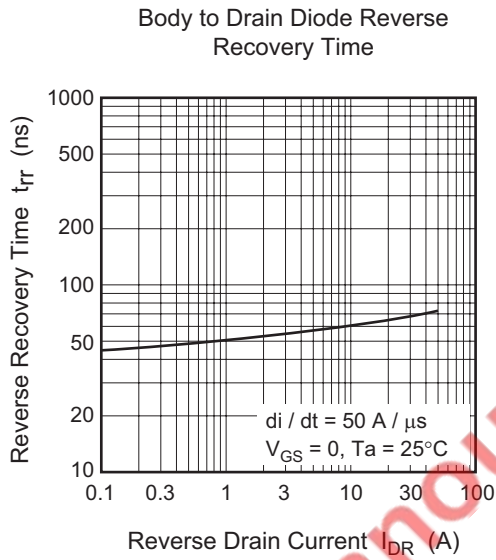
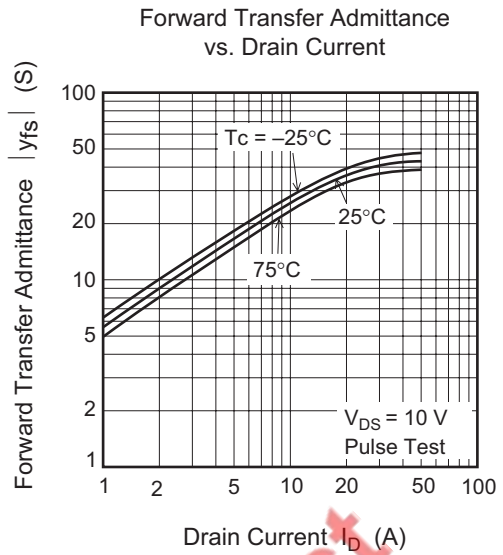
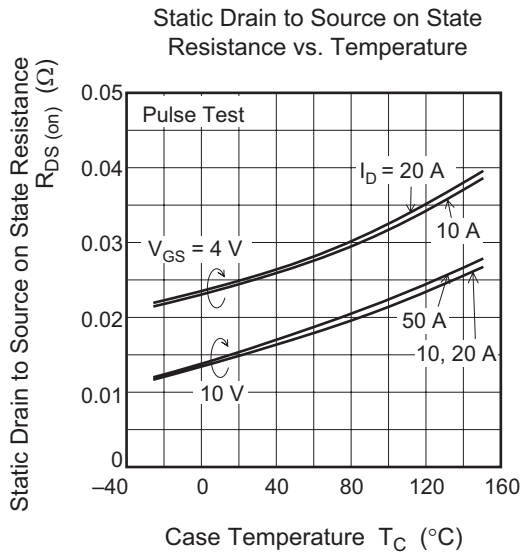
(Ta = 25°C)

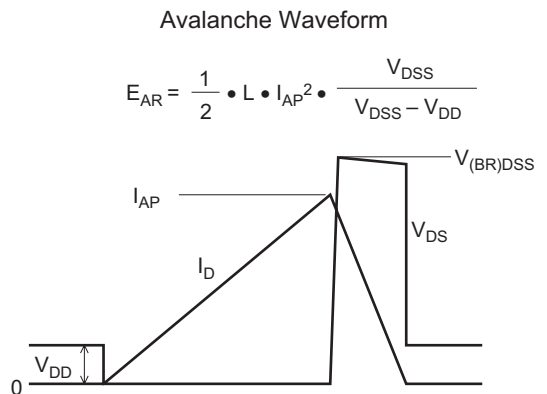
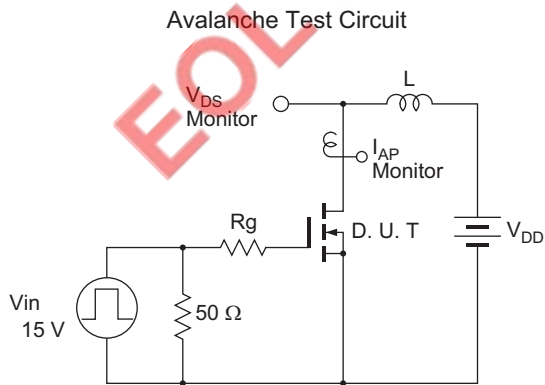
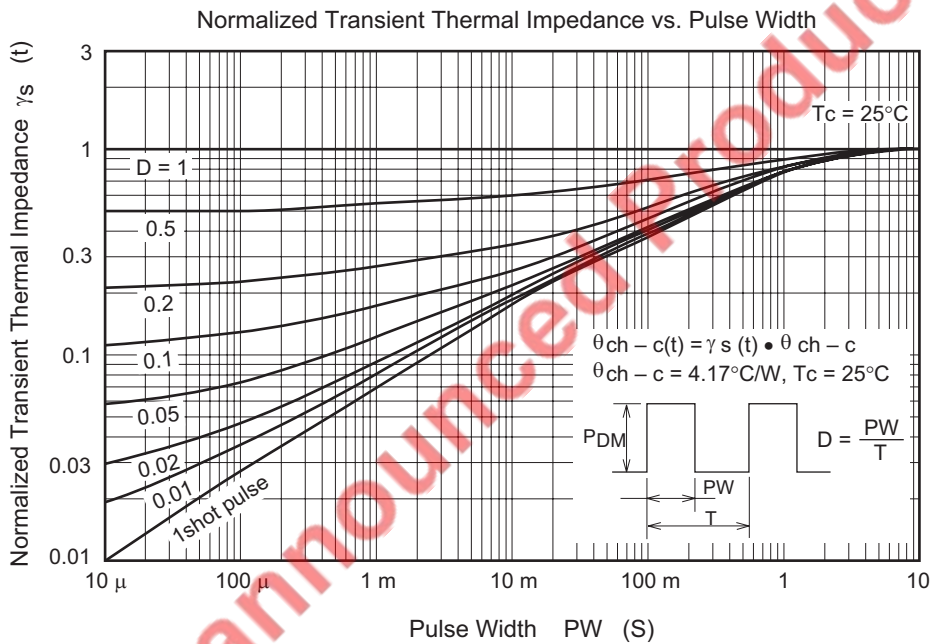
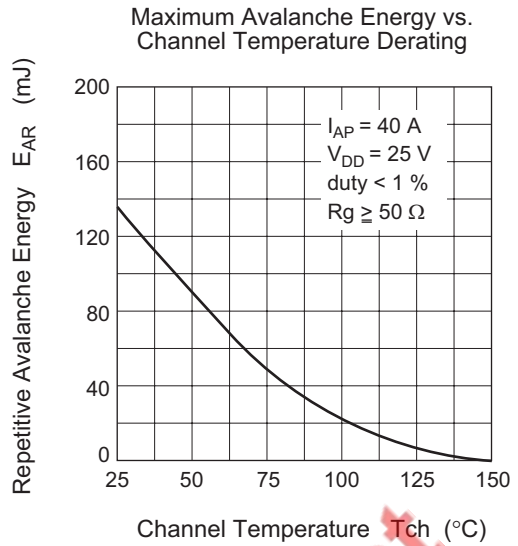
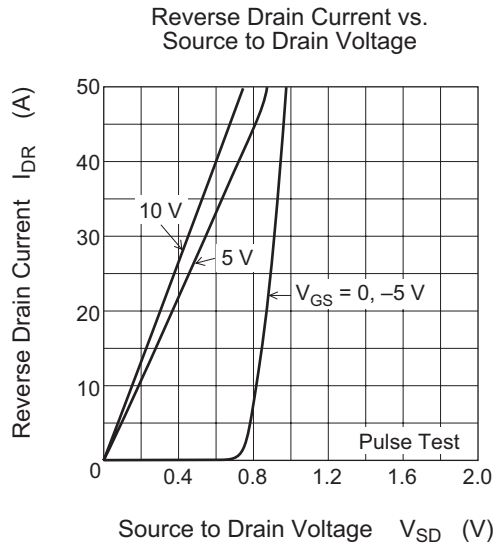
| Item                                       | Symbol        | Min | Typ  | Max | Unit | Test Conditions  |
|--|---------------|-----|------|-----|------|--|
| Drain to source breakdown voltage          | $V_{(BR)DSS}$ | 60  | —    | —   | V    | $I_D = 10 \text{ mA}$ , $V_{GS} = 0$                                   |
| Gate to source breakdown voltage           | $V_{(BR)GSS}$ | ±20 | —    | —   | V    | $I_G = \pm 100 \mu A$ , $V_{DS} = 0$                                   |
| Gate to source leak current                | $I_{GSS}$     | —   | —    | ±10 | μA   | $V_{GS} = \pm 16 \text{ V}$ , $V_{DS} = 0$                             |
| Zero gate voltage drain current            | $I_{DSS}$     | —   | —    | 10  | μA   | $V_{DS} = 60 \text{ V}$ , $V_{GS} = 0$                                 |
| Gate to source cutoff voltage              | $V_{GS(off)}$ | 1.5 | —    | 2.5 | V    | $I_D = 1 \text{ mA}$ , $V_{DS} = 10 \text{ V}$                         |
| Static drain to source on state resistance | $R_{DS(on)}$  | —   | 15   | 20  | mΩ   | $I_D = 20 \text{ A}$ , $V_{GS} = 10 \text{ V}^{*4}$                    |
|  | $R_{DS(on)}$  | —   | 25   | 40  | mΩ   | $I_D = 20 \text{ A}$ , $V_{GS} = 4 \text{ V}^{*4}$                     |
| Forward transfer admittance                | $ y_{fs} $    | 20  | 35   | —   | S    | $I_D = 20 \text{ A}$ , $V_{DS} = 10 \text{ V}^{*4}$                    |
| Input capacitance                          | $C_{iss}$     | —   | 1500 | —   | pF   | $V_{DS} = 10 \text{ V}$ , $V_{GS} = 0$ ,                               |
| Output capacitance                         | $C_{oss}$     | —   | 720  | —   | pF   | $f = 1 \text{ MHz}$  |
| Reverse transfer capacitance               | $C_{rss}$     | —   | 200  | —   | pF   |  |
| Turn-on delay time                         | $t_{d(on)}$   | —   | 20   | —   | ns   | $I_D = 20 \text{ A}$ , $V_{GS} = 10 \text{ V}$ ,<br>$R_L = 1.5 \Omega$ |
| Rise time                                  | $t_r$         | —   | 180  | —   | ns   |  |
| Turn-off delay time                        | $t_{d(off)}$  | —   | 200  | —   | ns   |  |
| Fall time                                  | $t_f$         | —   | 200  | —   | ns   |  |
| Body to drain diode forward voltage        | $V_{DF}$      | —   | 0.95 | —   | V    | $I_F = 40 \text{ A}$ , $V_{GS} = 0$                                    |
| Body to drain diode reverse recovery time  | $t_{rr}$      | —   | 70   | —   | V    | $I_F = 40 \text{ A}$ , $V_{GS} = 0$<br>$di_F/dt = 50 \text{ A}/\mu s$  |

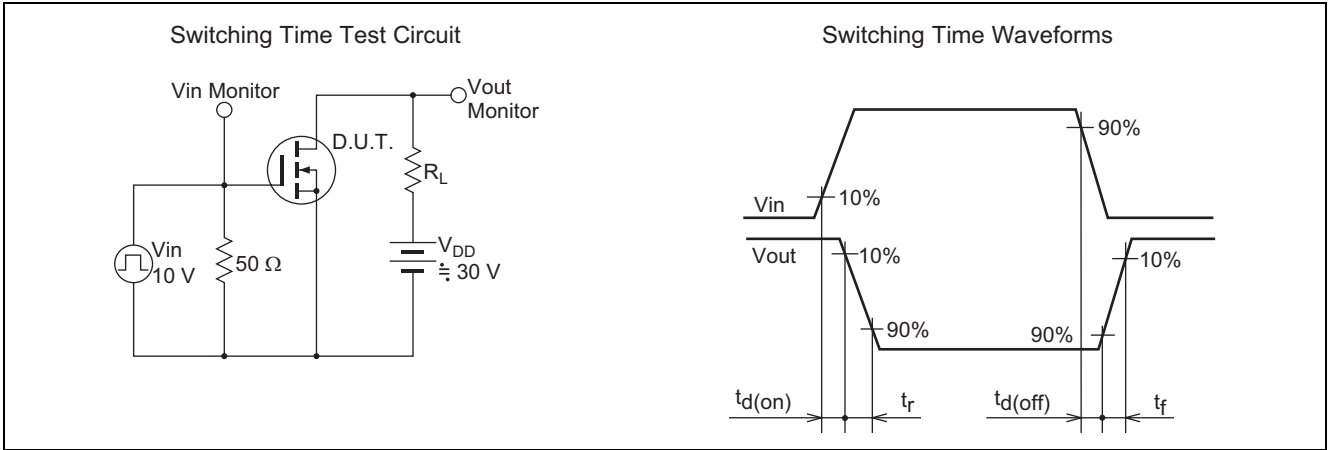
- Note: 4. Pulse test

Main Characteristics





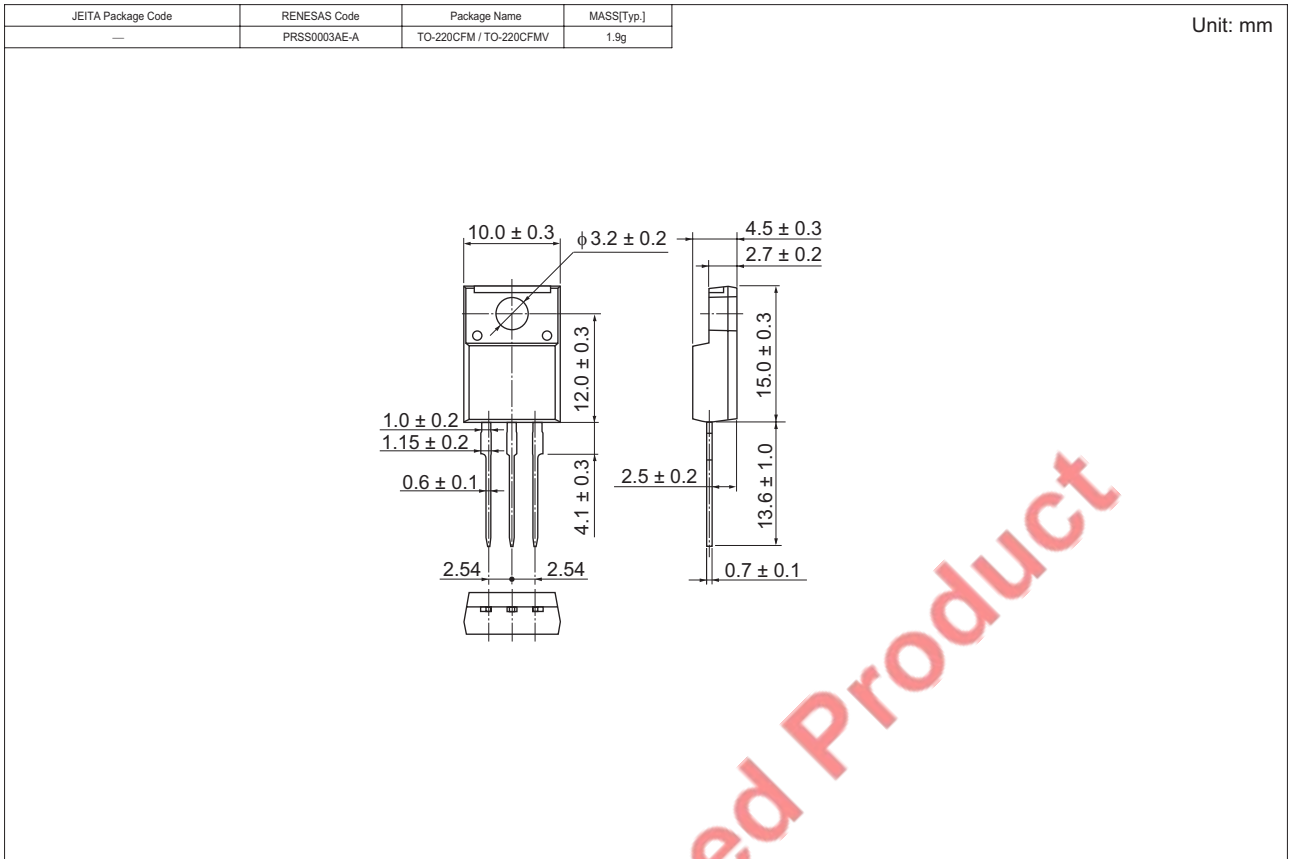




EOL announced Product



### Package Dimensions



### Ordering Information

| Part Name | Quantity | Shipping Container |
|-----------|----------|--------------------|
| 2SK2738-E | 50 pcs   | Plastic magazine   |

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

EOL announced Product

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Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

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#### Renesas Technology Hong Kong Ltd.

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Tel: <852> 2265-6688, Fax: <852> 2730-6071

#### Renesas Technology Taiwan Co., Ltd.

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#### Renesas Technology (Shanghai) Co., Ltd.

Unit2607 Ruijing Building, No.205 Maoming Road (S), Shanghai 200020, China  
Tel: <86> (21) 6472-1001, Fax: <86> (21) 6415-2952

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1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632  
Tel: <65> 6213-0200, Fax: <65> 6278-8001

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Tel: <82> 2-796-3115, Fax: <82> 2-796-2145

#### Renesas Technology Malaysia Sdn. Bhd.

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